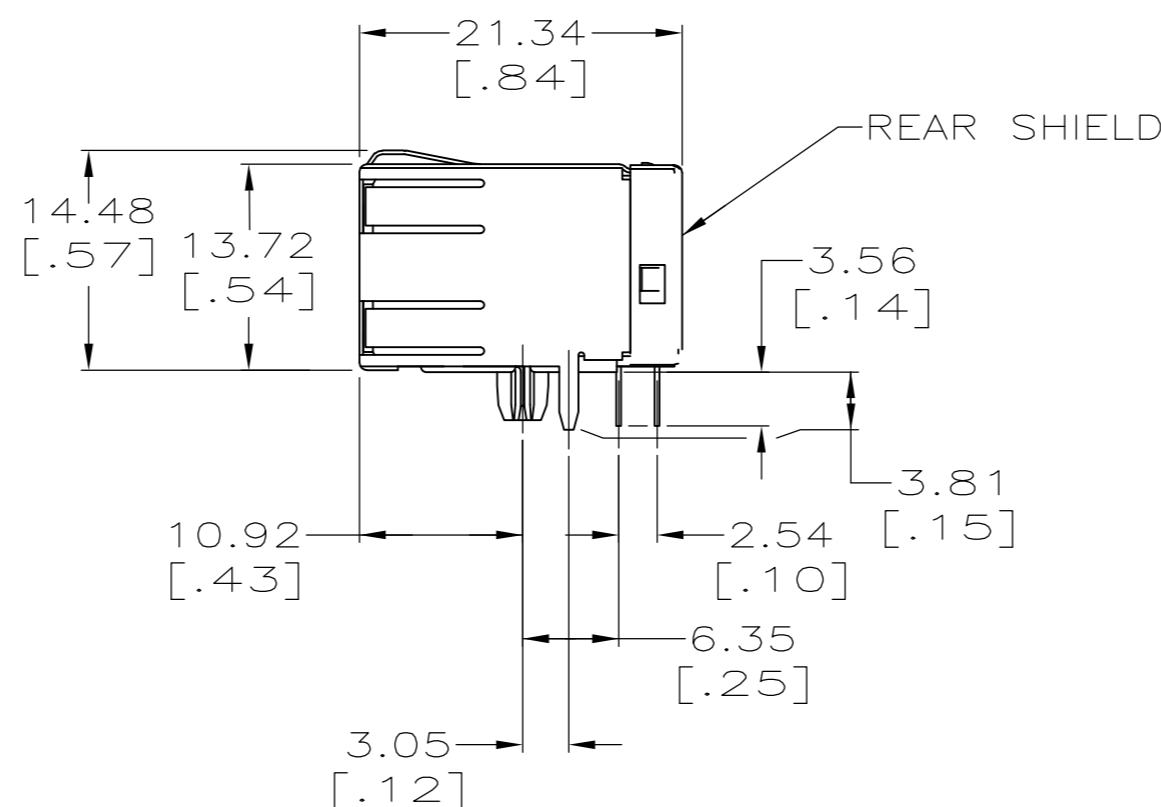
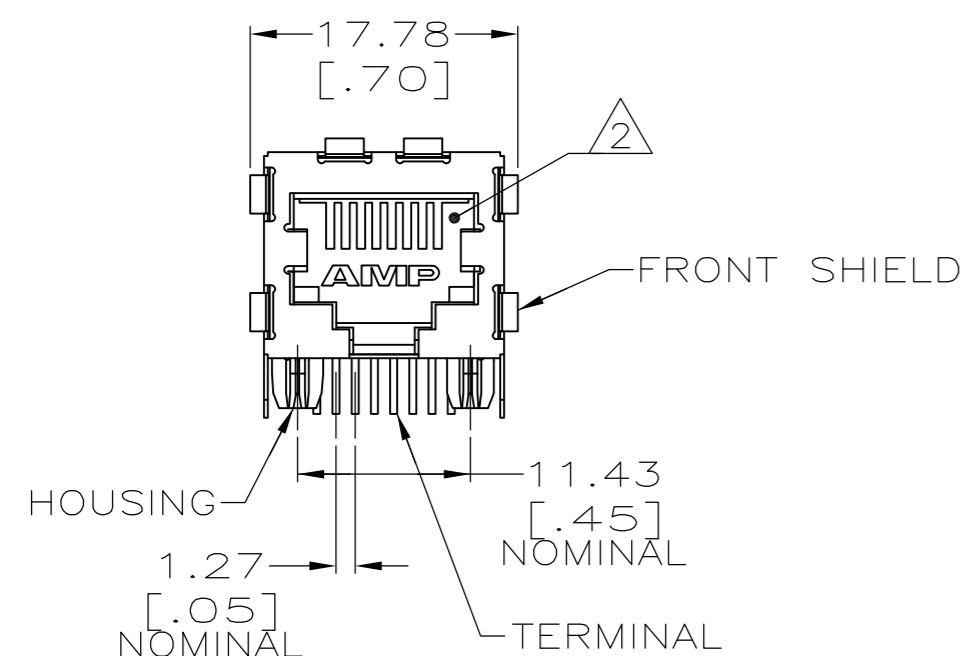


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AA	22		D	ECR-11-024835	20FEB2012	JJ	AC

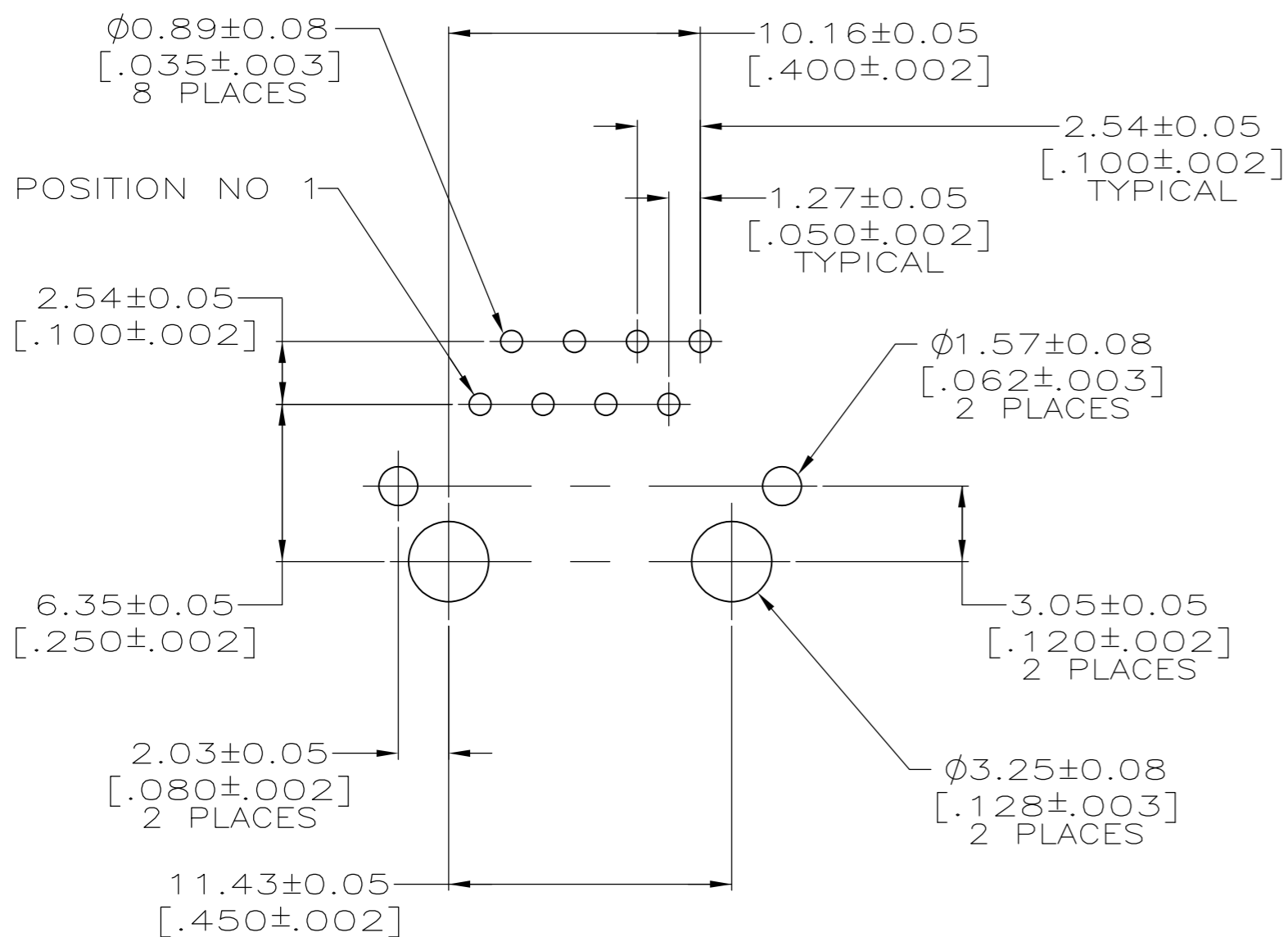


① MATERIAL: HOUSING – NYLON, BLACK, IR REFLOW COMPATIBLE, UL 94V-0.
 TERMINALS – 0.33 [.013] THICK PHOS BRONZE PLATED WITH 1.27 µm [.000050] MINIMUM THICK HARD GOLD IN LOCALIZED AREA AND 3.81 µm [.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 µm [.000050] MINIMUM THICK NICKEL UNDERPLATE.
 SHIELDS – 0.25 [.010] THICK COPPER ALLOY PLATED WITH 2.03 µm [.000080] MINIMUM BRIGHT TIN OVER 1.27 µm [.000050] MINIMUM NICKEL

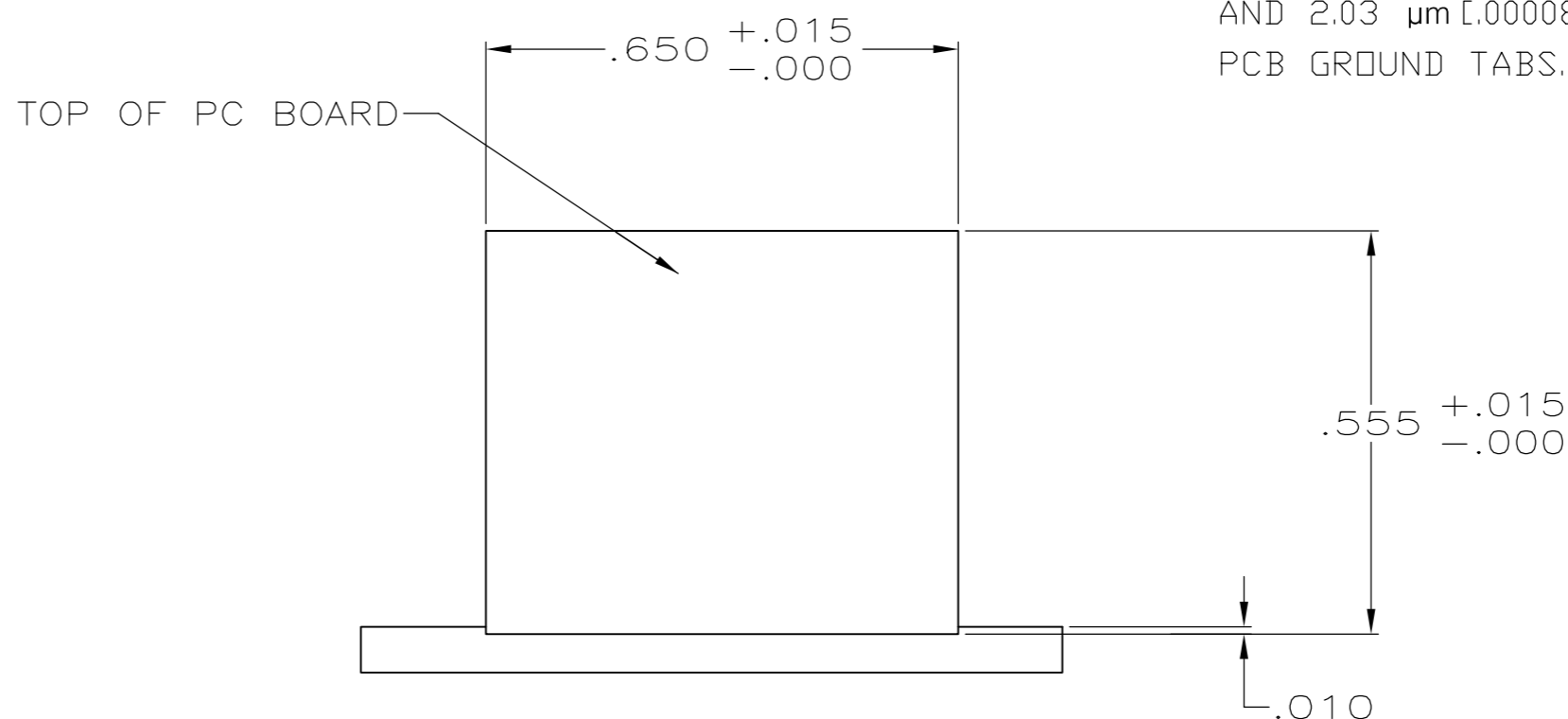
② JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.

③ USE #30 DRILL BIT OR 3.25mm DRILL BIT WHEN PRODUCING THESE PCB HOLES.

④ MATERIAL: HOUSING – NYLON, BLACK, IR REFLOW COMPATIBLE, UL 94V-0.
 TERMINALS – 0.33 [.013] THICK PHOS BRONZE PLATED WITH 1.27 µm [.000050] MINIMUM THICK HARD GOLD IN LOCALIZED AREA AND 3.81 µm [.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 µm [.000050] MINIMUM THICK NICKEL UNDERPLATE.
 SHIELDS – 0.25 [.010] THICK COPPER ALLOY PLATED WITH 1.27 µm [.000050] MINIMUM NICKEL AND 2.03 µm [.000080] MINIMUM HOT TIN DIP ON PCB GROUND TABS.



SUGGESTED PC BOARD LAYOUT
 COMPONENT SIDE
 SCALE 4:1



SUGGESTED PANEL CUTOUT
 SCALE 4:1

SUPERSEDED BY -2	REMARK	5406298-2	5406298-1
		PART NUMBER	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN T. SPRINKLE/L.A.MAYER 20APR2005	TE Connectivity	
DIMENSIONS: mm		CHK J.WESTMAN 20APR2005	NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD S.FLICKINGER 20APR2005	PRODUCT SPEC	
0 PLC ± -		108-1163	APPLICATION SPEC	
1 PLC ± -		114-2048	SIZE A2	CAGE CODE 00779
2 PLC ± 0.25[.01]		WEIGHT -	DRAWING NO C=5406298	RESTRICTED TO -
3 PLC ± 0.13[.005]		CUSTOMER DRAWING	SCALE 2:1	SHEET 1 OF 1
4 PLC ± -			REV D	
ANGLES ± -				
FINISH				
SEE NOTE 1&4				